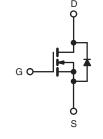
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY							
V _{DS} (V)	200)					
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.40						
Q _g (Max.) (nC)	43						
Q _{gs} (nC)	7.0						
Q _{gd} (nC)	23						
Configuration	Single						





N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION								
D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)						
SiHF630S-GE3	SiHF630STRL-GE3ª	SiHF630STRR-GE3ª						
IRF630SPbF	IRF630STRLPbF ^a	IRF630STRRPbF ^a						
SiHF630S-E3	SiHF630STL-E3 ^a	SiHF630STR-E3 ^a						
	SiHF630S-GE3 IRF630SPbF	SiHF630S-GE3SiHF630STRL-GE3aIRF630SPbFIRF630STRLPbFa						

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (Г _С = 25 °С, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	200	v
Gate-Source Voltage			V _{GS}	± 20	v
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	1-	9.0	
Continuous Drain Current	I _D	5.7	А		
Pulsed Drain Current ^a	I _{DM}	36			
Linear Derating Factor			0.59	W/°C	
Linear Derating Factor (PCB Mount) ^e		0.025	W/ C		
Single Pulse Avalanche Energy ^b			E _{AS}	250	mJ
Repetitive Avalanche Current ^a			I _{AR}	9.0	А
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ
Maximum Power Dissipation	P	74			
Maximum Power Dissipation (PCB Mount) ^e	P _D	3.0			
Pb containing terminations are not RoHS complia	ant, exemptions m	ay apply			•
Peak Diode Recovery dV/dt ^c			dV/dt	5.0	V/ns

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HALOGEN FREE

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ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)							
PARAMETER		SYMBOL	LIMIT	UNIT			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C				
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	U U			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 4.6 mH, $R_g = 25 \Omega$, $I_{AS} = 9.0 \text{ A}$ (see fig. 12). c. $I_{SD} \le 9.0 \text{ A}$, dI/dt $\le 120 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	-	-	40				
Maximum Junction-to-Ambient	R _{thJA}	-	-	62	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	1.7				

SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	se noted)					
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.24	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 V$	-	-	± 100	nA
Zana Oata Maltana Duain Ourrant		V _{DS} =	= 200 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 160V	∕, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 5.4 A ^b	-	-	0.40	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	3.8	-	-	S	
Dynamic	•						•
Input Capacitance	C _{iss}	V_{GS} = 0 V, V_{DS} = 25 V,		-	800	-	pF
Output Capacitance	C _{oss}			-	240	-	
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	76	-	
Total Gate Charge	Qg			-	-	43	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 5.9 A, V _{DS} = 160 V see fig. 6 and 13 ^b	-	-	7.0	nC
Gate-Drain Charge	Q _{gd}		boo ng. o ana ro	-	-	23	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 100 \text{ V}, \text{ I}_D = 5.9 \text{ A}$ $R_g = 12 \Omega, R_D = 16 \Omega$ see fig. 10^{b}		-	9.4	-	
Rise Time	t _r			-	28	-	- ns
Turn-Off Delay Time	t _{d(off)}			-	39	-	
Fall Time	t _f		-	20	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal Source Inductance	L _S	package and die contact		-	7.5	-	nH

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)									
PARAMETER	SYMBOL TEST CONDITIONS MIN. TYP.								
Drain-Source Body Diode Characteristics									
Continuous Source-Drain Diode Current	IS	MOSFET symbol showing the	-	-	9.0	A			
Pulsed Diode Forward Current ^a	I _{SM}	p - n junction diode	-	-	36	~			
Body Diode Voltage	V _{SD}	T_J = 25 °C, I_S = 9.0 A, V_{GS} = 0 V ^b	-	-	2.0	V			
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 5.9 A,	-	170	340	ns			
Body Diode Reverse Recovery Charge	Q _{rr}	dl/dt = 100 A/µs ^b	-	1.1	2.2	μC			
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR-4 or G-10 material).

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

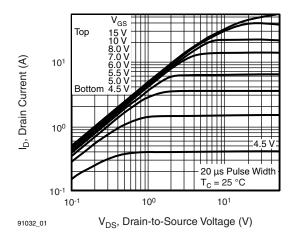


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

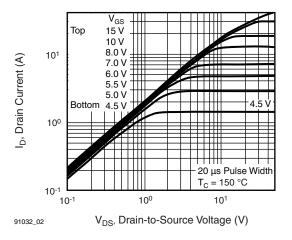


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$

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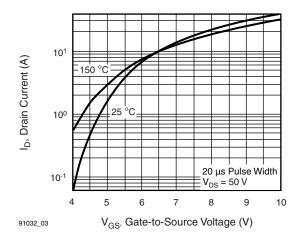
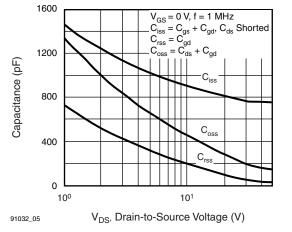
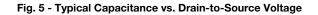


Fig. 3 - Typical Transfer Characteristics





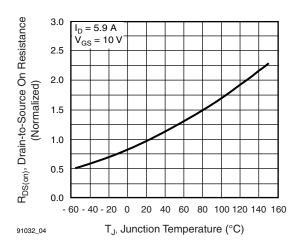


Fig. 4 - Normalized On-Resistance vs. Temperature

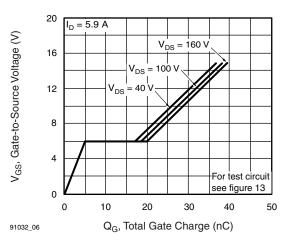


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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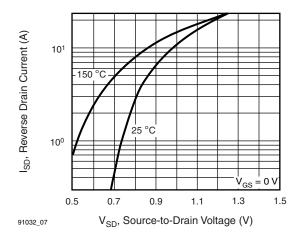


Fig. 7 - Typical Source-Drain Diode Forward Voltage

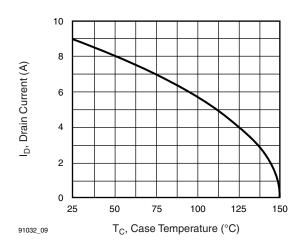


Fig. 9 - Maximum Drain Current vs. Case Temperature

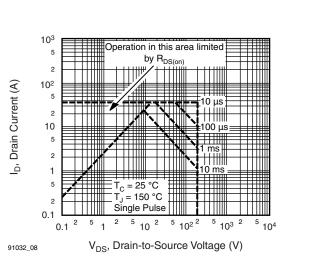


Fig. 8 - Maximum Safe Operating Area

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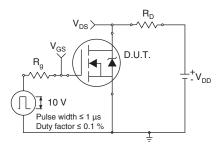


Fig. 10a - Switching Time Test Circuit

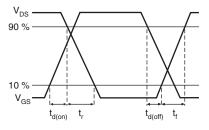
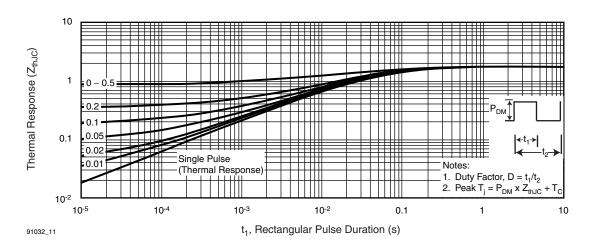


Fig. 10b - Switching Time Waveforms

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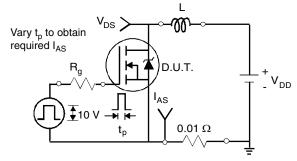


Fig. 12a - Unclamped Inductive Test Circuit

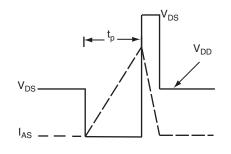
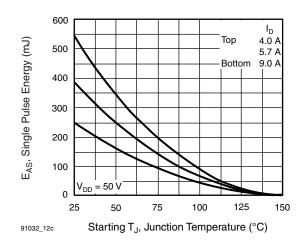
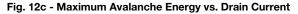


Fig. 12b - Unclamped Inductive Waveforms



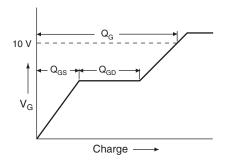


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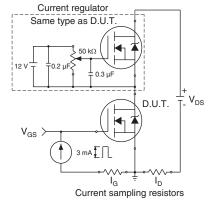
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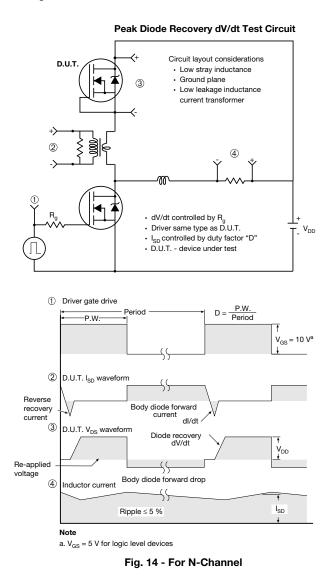
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TO-263AB (HIGH VOLTAGE)

/3 ⁄4

2 x 🗗

A

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-2 x b2 <−2 x b

⊕ 0.010
 M A
 M B

Plating

ł

Detail A

(Datum A)

D

 $\underline{4}$ 11

		Lead tip		(c) (c) (b, b) <u>Section B-</u> Scale	3 and C - C		Vi		4	
	MILLI	METERS	INC	CHES			MILLI	METERS	INC	CHES
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190	F	D1	6.86	-	0.270	-
A1	0.00	0.25	0.000	0.010		Е	9.65	10.67	0.380	0.420
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b1	0.51	0.89	0.020	0.035		е	2.54	BSC	0.100	0 BSC
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625
b3	1.14	1.73	0.045	0.068		L	1.78	2.79	0.070	0.110
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066
c1	0.38	0.58	0.015	0.023		L2	-	1.78	-	0.070
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010	0 BSC
D	8.38	9.65	0.330	0.380		L4	4.78	5.28	0.188	0.208

Α

Δ

// ± 0.004 M B

b1, b3

Base metal

- Notes
- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



H

B

A1

D1 4

Gauge plane

. Ŀ3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane



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